

Ceramic, High Q, Microwave (CBR), 6.8 pF, +/-0.1 pF, 50 V, 0402, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I



Dimensions

L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
T	0.5mm +/-0.05mm
B	0.25mm +0.05/-0.1mm

Packaging Specifications

Packaging:	T&R, 180mm, Plastic Tape
Packaging Quantity:	10000

General Information

Style:	SMD Chip
Series:	Microwave (CBR)
Chip Size:	0402
Description:	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features:	Ultra High Q, Low ESR, Class I
RoHS:	Yes
Termination:	Tin
Marking:	No
Miscellaneous:	Minimum Q = 936
Notes:	Solder Reflow Only

Specifications

Capacitance:	6.8 pF
Capacitance Tolerance:	+/-0.1 pF
Voltage DC:	50 VDC
Dielectric Withstanding Voltage:	125 V
Temperature Range:	-55/+125C
Temperature Coefficient:	COG
Dissipation Factor:	0.187%
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	10 GOhms
Quality Factor:	936

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